STC5NF30V

N-CHANNEL 30V - 0.027 Ω - 5A TSSOP8
2.7V-DRIVE STripFET™ II POWER MOSFET

| TYPE	V_{DSS}	$R_{DS(on)}$	I_D
STC5NF30V	30 V	< 0.031 Ω (@ 4.5 V) < 0.035 Ω (@ 2.7 V)	5 A

- TYPICAL R_{DS}(on) = 0.027 Ω @ 4.5 V
- TYPICAL R_{DS}(on) = 0.031 Ω @ 2.7 V
- ULTRA LOW THRESHOLD GATE DRIVE (2.7 V)
- STANDARD OUTLINE FOR EASY AUTOMATED SURFACE MOUNT ASSEMBLY

DESCRIPTION

This Power MOSFET is the latest development of STMicroelectronis unique "Single Feature Size™" strip-based process. The resulting transistor shows extremely high packing density for low on-resistance, rugged avalanche characteristics and less critical alignment steps therefore a remark-able manufacturing reproducibility.

APPLICATIONS

- DC MOTOR DRIVE
- DC-DC CONVERTERS
- BATTERY MANAGEMENT IN NOMADIC EQUIPMENT
- POWER MANAGEMENT IN PORTABLE/DESKTOP PCs

TSSOP8
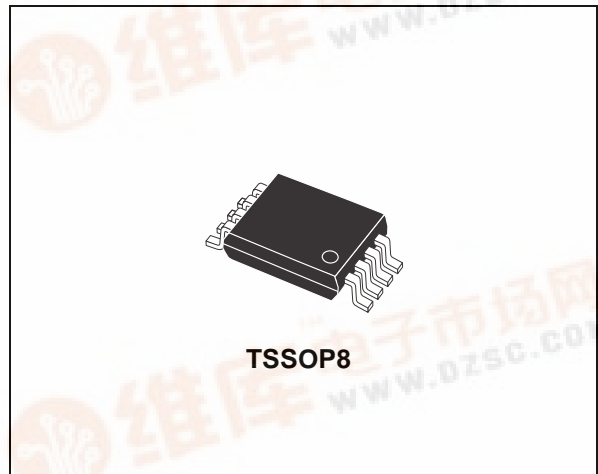
INTERNAL SCHEMATIC DIAGRAM

SC15210
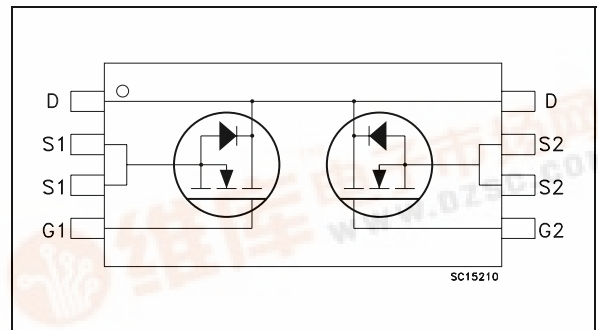
ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{DS}	Drain-source Voltage (V_{GS} = 0)	30	V
V_{DGR}	Drain-gate Voltage (R_{GS} = 20 kΩ)	20	V
V_{GS}	Gate- source Voltage	± 12	V
I_D	Drain Current (continuous) at T_C = 25°C	5	A
I_D	Drain Current (continuous) at T_C = 100°C	3	A
I_{DM}(•)	Drain Current (pulsed)	20	A
P_{tot}	Total Dissipation at T_C = 25°C	1.5	W

(•) Pulse width limited by safe operating area.

STC5NF30V

THERMAL DATA

Rthj-pcb	Thermal Resistance Junction-PCB (**)	Max	100	°C/W
Rthj-pcb	Thermal Resistance Junction-PCB (*)	Max	83.5	°C/W
T_j	Operating Junction Temperature		-55 to 150	°C
T_{stg}	Storage temperature		-55 to 150	°C

(*) When Mounted on FR-4 board with 1 inch^2 pad, 2 oz of Cu and t ≤ 10 sec
(**) When Mounted on minimum recommended footprint

ELECTRICAL CHARACTERISTICS (T_{case} = 25 °C unless otherwise specified)

OFF

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source Breakdown Voltage	I_D = 250 µA, V_{GS} = 0	30			V
I_{DSS}	Zero Gate Voltage Drain Current (V_{GS} = 0)	V_{DS} = Max Rating V_{DS} = Max Rating T_C = 125°C			1 10	µA µA
I_{GSS}	Gate-body Leakage Current (V_{DS} = 0)	V_{GS} = ± 12V			±100	nA

ON (*)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS} = V_{GS} I_D = 250 µA	0.6			V
$R_{DS(on)}$	Static Drain-source On Resistance	V_{GS} = 4.5 V I_D = 2.5 A V_{GS} = 2.7 V I_D = 2.5 A		0.027 0.031	0.031 0.035	Ω Ω

DYNAMIC

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
g_{fs} (*)	Forward Transconductance	V_{DS}=15 V I_D = 2.5 A		9.5		S
C_{iss} C_{oss} C_{rss}	Input Capacitance Output Capacitance Reverse Transfer Capacitance	V_{DS} = 15V f = 1 MHz, V_{GS} = 0		460 200 50		pF pF pF

ELECTRICAL CHARACTERISTICS (continued)

SWITCHING ON

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$ t_r	Turn-on Delay Time Rise Time	V_{DD} = 10 V $\quad$ I_D = 2.5 A R_G = 4.7 Ω $\quad$ V_{GS} = 4.5 V (Resistive Load, Figure 1)		7 33		ns ns
Q_g Q_{gs} Q_{gd}	Total Gate Charge Gate-Source Charge Gate-Drain Charge	V_{DD}= 16V $\;$ I_D= 5A $\;$ V_{GS}=4.5V (see test circuit, Figure 2)		8.5 1.8 2.4	11.5	nC nC nC

SWITCHING OFF

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$t_{d(off)}$ t_f	Turn-off Delay Time Fall Time	V_{DD} = 10 V $\quad$ I_D = 2.5 A R_G = 4.7Ω, $\quad$ V_{GS} = 4.5 V (Resistive Load, Figure 1)		27 10		ns ns
$t_{d(Voff)}$ t_f t_c	Off-voltage Rise Time Fall Time Cross-over Time	V_{clamp} = 16 V $\quad$ I_D = 5 A R_G = 4.7Ω, $\quad$ V_{GS} = 4.5 V (Inductive Load, Figure 3)		26 11 21		ns ns ns

SOURCE DRAIN DIODE

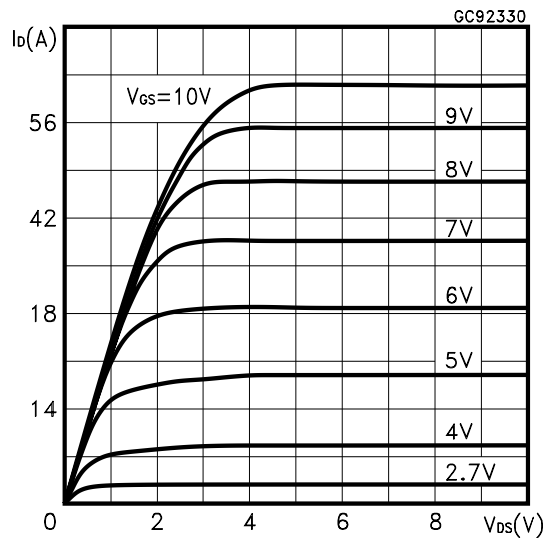| Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
I_{SD} I_{SDM} (●)	Source-drain Current Source-drain Current (pulsed)				5 20	A A
V_{SD} (*)	Forward On Voltage	I_{SD} = 5 A $\quad$ V_{GS} = 0			1.2	V
t_{rr} Q_{rr} I_{RRM}	Reverse Recovery Time Reverse Recovery Charge Reverse Recovery Current	I_{SD} = 5 A $\quad$ di/dt = 100A/μs V_{DD} = 10 V $\quad$ T_j = 150°C (see test circuit, Figure 3)		26 13 1		ns nC A

(*)Pulsed: Pulse duration = 300 μs, duty cycle 1.5 %.
(●)Pulse width limited by safe operating area.

Safe Operating Area
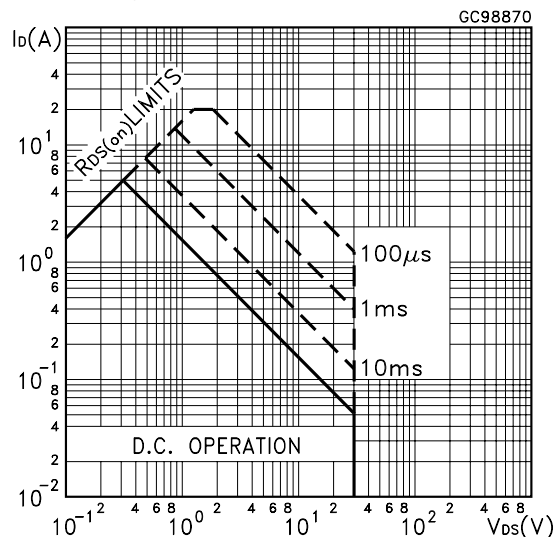
Thermal Impedance
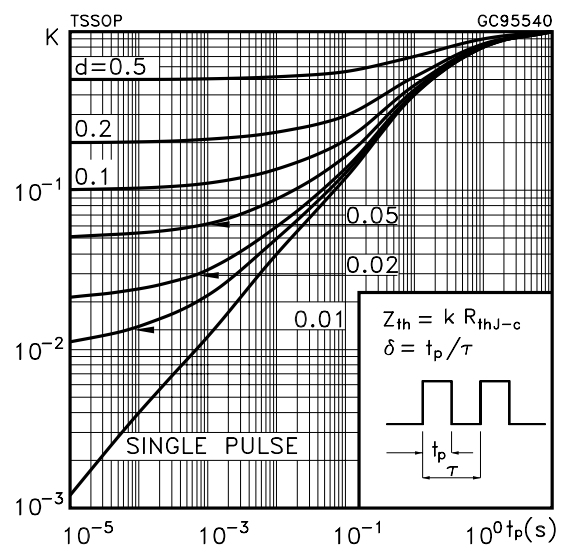
STC5NF30V

Output Characteristics
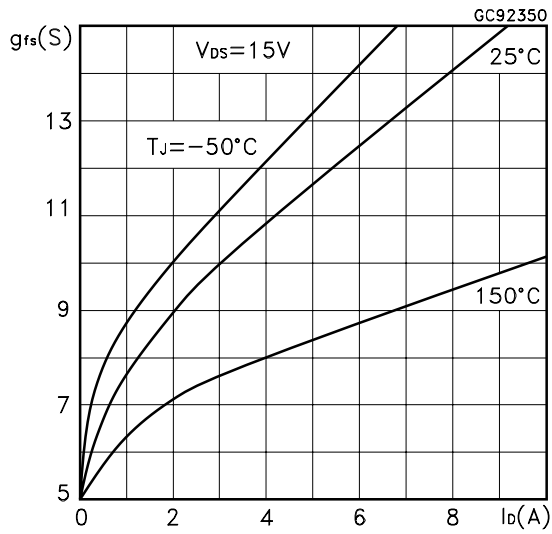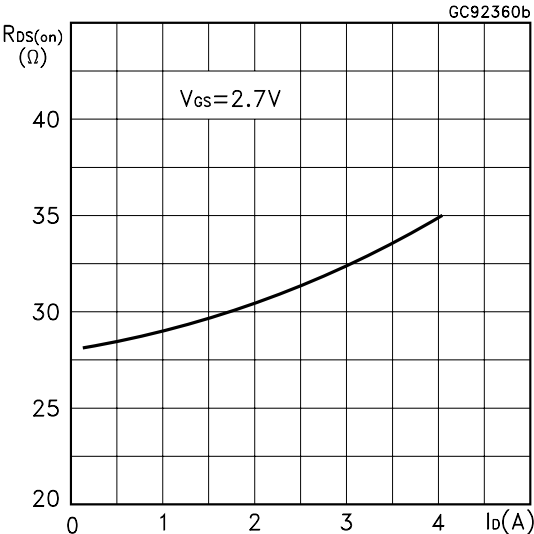
GC92330

$I_D(A)$

$V_{GS}=10V$ 9V 8V 7V 6V 5V 4V 2.7V

56

42

18

14

0 2 4 6 8 $V_{DS}(V)$

Transfer Characteristics

GC92340

$I_D(A)$

56

42

18

14

$V_{DS}=10V$

0 2 4 6 8 $V_{GS}(V)$

Transconductance

GC92350

$g_{fs}(S)$

$V_{DS}=15V$ 25°C

13

$T_J=-50°C$

11

9

150°C

7

5

0 2 4 6 8 $I_D(A)$

Static Drain-source On Resistance

GC92360b

$R_{DS(on)}$ (Ω)

$V_{GS}=2.7V$

40

35

30

25

20

0 1 2 3 4 $I_D(A)$
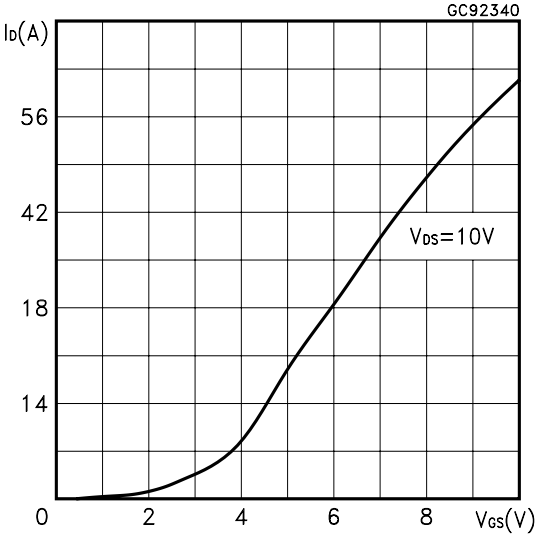
Gate Charge vs Gate-source Voltage

GC92370D

$V_{GS}(V)$

$V_{DS}=16V$
$I_D=5A$

8

6

4

2

0 4 8 12 16 $Q_g(nC)$
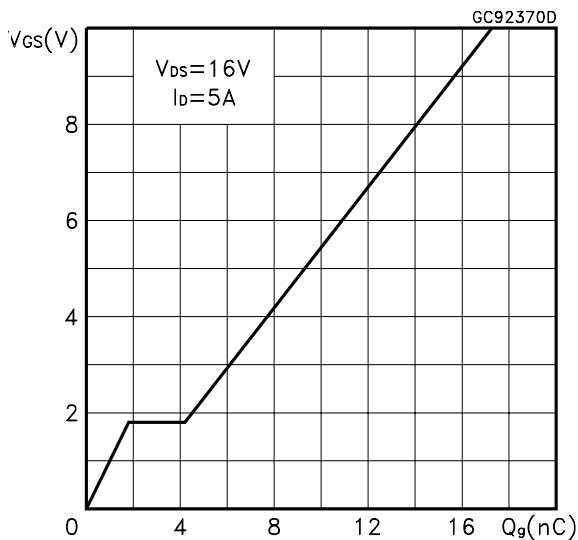
Capacitance Variations

GC92380

$C(pF)$

$f=1MHz$
$V_{GS}=0V$

800

600

C_{iss}

400

200

C_{oss}

C_{rss}

0 3 6 9 12 $V_{DS}(V)$
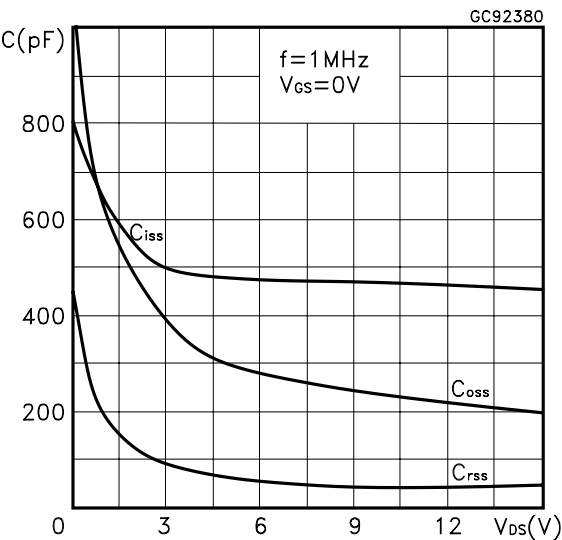
Normalized Gate Threshold Voltage vs Temperature

GC92390

V_GS(th) (norm)

$V_{DS}=V_{GS}$
$I_D=250\mu A$

1.2

1.0

0.8

0.6

0.4

−50   0   50   100   TJ(°C)
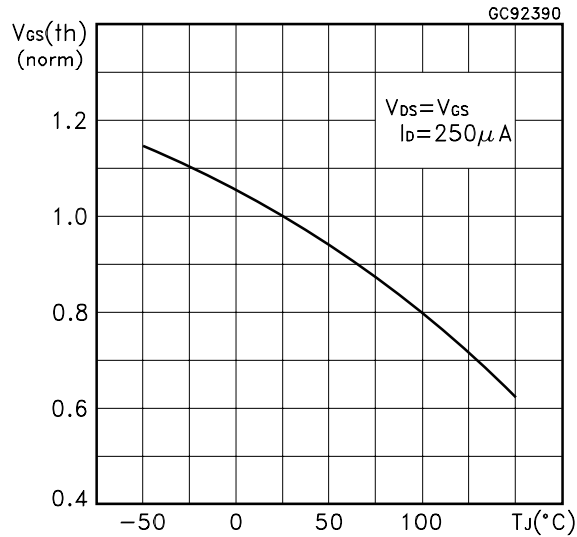
Normalized on Resistance vs Temperature

GC92400D

R_DS(on) (norm)

$V_{GS}=10V$
$I_D=2.5A$

1.4

1.2

1.0

0.8

0.6

−50   0   50   100   TJ(°C)
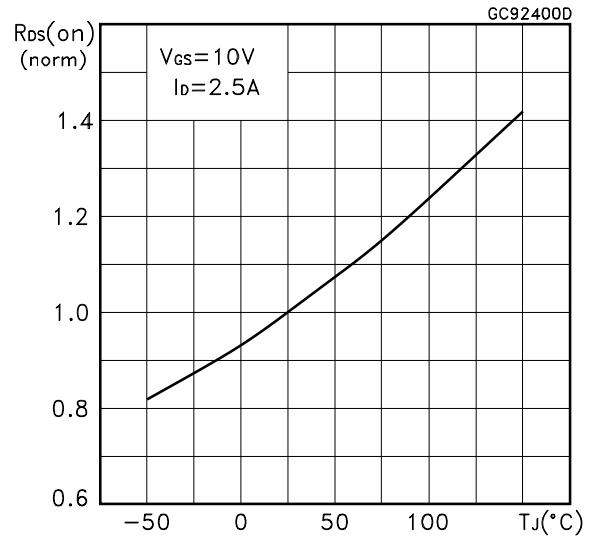
Source-drain Diode Forward Characteristics

GC92410

V_SD(V)

$T_J=-40°C$

0.9

25°C

0.8

0.7

150°C

0.6

0.5

1   2   3   4   5   I_SD(A)
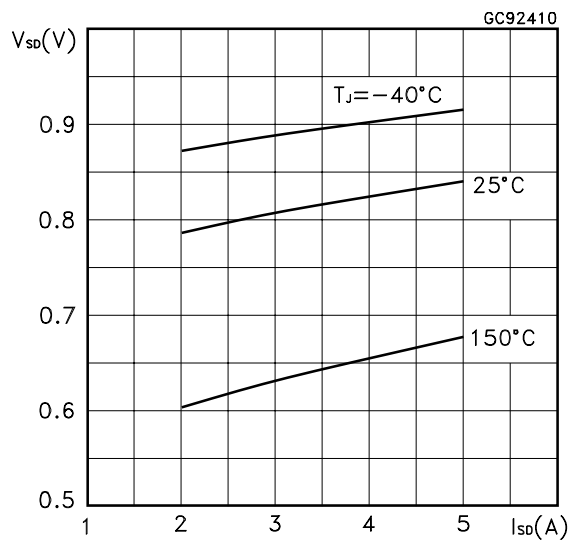
Thermal resistance and max power

Rthj−PCB (°C/W)   Pd(w)

100   2.0

FR−4 Board, 2 oz Cu, t<10s.

95   1.6

90   1.2

85   0.8

80   0.4

Minimum recommended footprint

75   0.0

0   200   400   600   PCB size (sqm)

Fig. 1: Switching Times Test Circuits For Resistive Load

SC05990

Fig. 2: Gate Charge test Circuit

SC06000

Fig. 3: Test Circuit For Diode Recovery Behaviour

SC06010
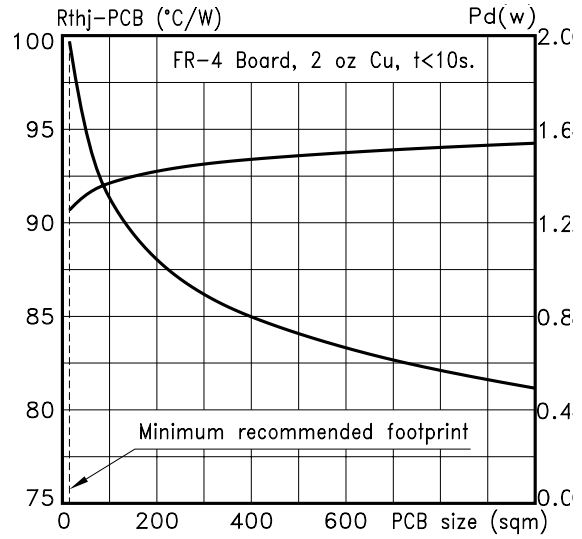
TSSOP8 MECHANICAL DATA

DIM.	mm.			inch.		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	1.05		1.20	0.041		0.047
A1	0.05		0.15	0.002		0.006
A2	0.80		1.05	0.032		0.041
b	0.19		0.30	0.008		0.012
c	0.090		0.20	0.003		0.007
D	2.90		3.10	0.114		0.122
E	6.20		6.60	0.240		0.260
E1	4.30		4.50	0.170		0.177
e		0.65			0.025	
L	0.45		0.75	0.018		0.030
L1		1.00			0.039	
k	0º		8º	0.192		0.208

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